

# L-Band, GaN/SiC, RF Power Module

1.2 - 1.4 GHz | 3700 W typ | 75% Efficiency typ | 18 dB Gain typ | 100 V | 100  $\mu s$  Pulse Length, 4% Duty Cycle

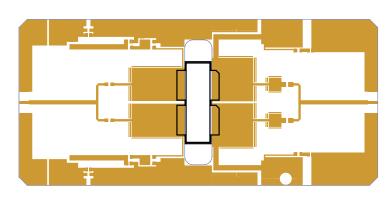
IGNP1214M3200 is a high power GaN-on-SiC RF power module that has been designed to suit the unique needs of modern long-range radar systems. It supplies a minimum of 3200 W of peak output power, with typically >18 dB of associated gain and 68% efficiency. It operates from a 100 V supply voltage.

# **FEATURES**

- GaN on SiC HEMT Technology
- Output Power >3200 W
- High Efficiency up to 75%
- 100% RF Tested Under 100µs, 4% duty cycle pulse conditions
- Full non-linear electrothermal model available, please contact the factory

# **APPLICATIONS**

L-band Radar Systems



Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Gain	G	17	18	20	dB	P <sub>out</sub> = 3200W
Drain Efficiency	η	60	68	75	%	f = 1.2, 1.3, 1.4 GHz
Pulse Droop	D	-0.8	-0.4	+0.2	dB	
Load Mismatch Stability	VSWR-S	2:1				100µs pulse length 4% duty cycle pulse conditions
VSWR Withstand	VSWR-LMT	5:1				$V_{ps} = 100V, I_{ps} = 75mA \text{ per side}$

## Table 1. RF Electrical Characteristics (Case temperature = 30 °C unless otherwise stated)

Note: Consult Integra Technologies Application Note 001 for information on how RF output power and pulse droop are measured.



#### Table 2. Absolute Maximum Ratings (Not Simultaneous)

Parameter	Symbol	Value	Units	Test Conditions
DC Drain-Source Voltage	V <sub>DS</sub>	400	V	25 °C
DC Gate-Source Voltage	V <sub>GS</sub>	-8 to +1	V	25 °C
DC Drain Current	I <sub>D</sub>	144	А	25 °C
DC Gate Current	Ι <sub>G</sub>	144	mA	25 °C
RF Input Power	P <sub>RF,IN</sub>	115	W	25 °C
Operating Channel Temperature	Т <sub>сн</sub>	-55 to +225	٥C	
Storage Temperature	T <sub>stg</sub>	-55 to +150	٥C	
Soldering Temperature	T <sub>SOLDER</sub>	260 for 60s	٥C	

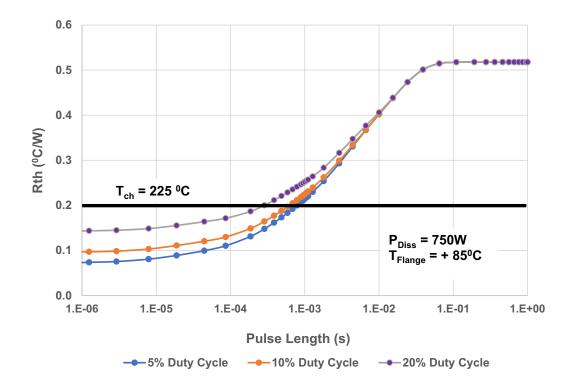
Note: Operation outside the limits given in this table may cause permanent damage to the transistor

## Table 3. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Мах	Units	Test Conditions
Gate Pinch-Off Voltage	V <sub>P</sub>	-5.0			V	$V_{_{\rm DS}} = 100$ V, $I_{_{\rm DS}} = 1$ mA
Quiescent Gate Voltage	V <sub>Q</sub>		-2.8		V	$V_{\rm DS}$ = 100V, $I_{\rm DS}$ = 75mA per side

## Table 4. Thermal Resistance (Case temperature = 85 °C unless otherwise stated)

Parameter	Symbol	Тур	Units	Test Conditions
Peak Thermal Resistance, Channel to Case, per side	R <sub>th</sub>	0.14	⁰C/W	$P_{_{DISS}} = 750W$ per side 100 $\mu$ s pulse length 4% duty cycle $V_{_{DS}} = 100V$





# **TYPICAL PERFORMANCE**

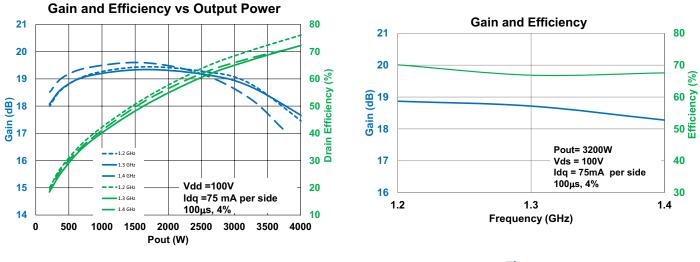


Figure 1

Figure 2

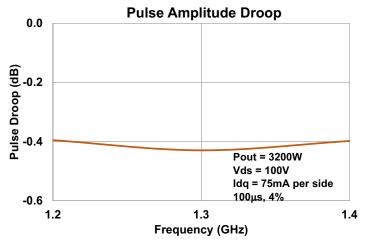
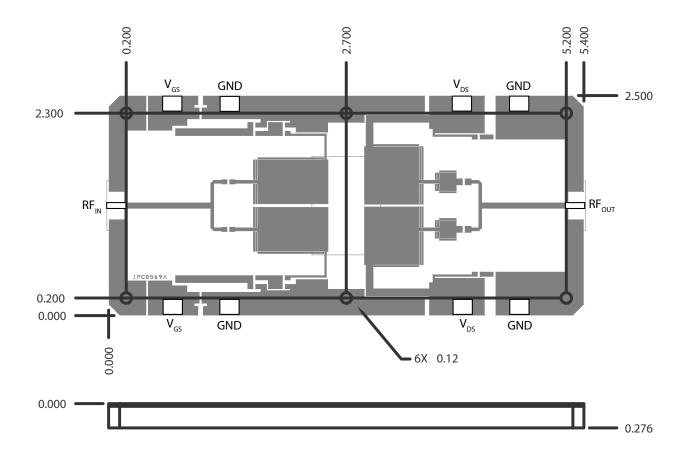


Figure 3



# **MECHANICAL DIMENSIONS**





## **ESD & MSL Rating**

Parameter	Rating	Standard	
ESD Human Body Model (HBM)	TBD	ESDA/JEDEC JS-001-2012	
ESD Charged Device Model (CDM)	TBD	JEDEC JESD22-C101F	
Moisture Sensitivty Level (MSL)	Unlimited Shelf Life	IPC/JEDEC J-STD-020	

## **REACH Compliance**

Integra Technologies supports EU Regulation number 1907/2006 concerning the Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH) as these apply to Integra semiconductor products, development tools, and shipping packaging.

In support of the REACH regulation, Integra will:

- -Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.
- •Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.
- •Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.
- Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

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DEFINITIONS:

DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications.

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications.

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.

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